### **Technical Specifications**

### **HP ProBook 455 G7 Notebook PC**



- 1. Internal Microphones (2)
- 2. Webcam
- 3. Privacy Shutter (Only available with webcam)
- 4. Webcam LED
- 5. Clickpad
- 6. Hard Drive LED

- 7. SD Card Reader
- 8. Thermal Vent
- 9. USB 2.0 Port
- 10. Standard Security Lock Slot (Lock sold separately)
- 11. Power Button



### **Technical Specifications**



#### Right

- 1. Power Connector
- 2. USB Type-C® 3.1 Gen 1 Port
- 3. Ethernet Port (RJ-45)
- 4. HDMI Port (Cable not included)

- 5. USB 3.1 Gen 1 Port
- 6. USB 3.1 Gen 1 Port
- 7. Headphone / Microphone Combo Jack
- 8. Fingerprint Sensor (select models)



### **Technical Specifications**

#### At a Glance

- Preinstalled Windows 10 versions or FreeDOS
- Choice of AMD Ryzen™ 4000 series mobile processors, R7, R5 and R3
- Display include your choice of 39.62 cm (15.6") diagonal HD, Ultra Wide Viewing Angle FHD, And Privacy Panel option
- Enhanced security features including TPM2.0, HP Sure Sense, HP Sure Start, HP BIOSphere, Hardware enforced Firmware Protection, optional Fingerprint sensor (select models)<sup>4</sup>, optional IR camera, and optional Privacy Panel
- Designed to pass 19 MIL-STD 810H testing<sup>1</sup>
- Weight starting at 4.41 lb (2.0kg) (Weight will vary by configuration)
- HP Long-Life Rechargeable battery, with HP Fast Charge Technology recharges 50% in 30 minutes<sup>2</sup>
- Up to 512 GB Solid State Drives and 1 TB Hard Drive
- Up to 16 GB total system memory
- 720p HD webcam, IR camera for face authentication with Windows Hello
- Spill-resistent and optional backlit Keyboard<sup>3</sup>, and Clickpad with multi-touch gestures enabled, taps enabled as default
- 1. MIL-STD-810H testing is not intended to demonstrate fitness of U.S. Department of Defense (DoD) contract requirements or for military use. Test results are not a guarantee of future performance under these test conditions. Accidental damage requires an optional HP Accidental Damage Protection Care Pack.
- 2. Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.
- 3. Backlit keyboard is an optional feature that must be configured at purchase
- 4. HP Fingerprint Sensor is an optional feature and requires configuration at purchase.

**NOTE:** See important legal disclosures for all listed specs in their respective features sections.



### **Technical Specifications**

#### **PRODUCT NAME**

HP ProBook 455 G7 Notebook PC

#### **OPERATING SYSTEMS**

Preinstalled Windows 10 Pro 64<sup>1</sup>

Windows 10 Pro 64 (National Academic only)2

Windows 10 Home 641

Windows 10 Home Single Language 64<sup>1</sup> Windows® 10 Enterprise 64 (Web Support)<sup>1</sup>

**FreeDOS** 

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com/">http://www.windows.com/</a>.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

#### **PROCESSORS**

AMD Ryzen™ 3 4300U APU with Renoir™ Vega 6 Graphics (2.7 GHz base clock, up to 3.7 GHz max boost clock, 4 MB L3 cache, four-cores)<sup>3,4,5,6</sup>

AMD Ryzen™ 5 4500U APU with Renoir™ Vega 8 Graphics (2.3 GHz base clock, up to 4.0 GHz max boost clock, 4 MB L3 cache, six-cores)<sup>3,4,5,6</sup>

AMD Ryzen™ 7 4700U APU with Renoir™ Vega 10 Graphics (2.0 GHz base clock, up to 4.1 GHz max boost clock, 4 MB L3 cache, eight-cores)<sup>3,4,5,6</sup>

#### **Processors Family**

AMD Ryzen™ 4000 Series Mobile processors6

- 3. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 4. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.
- 5. AMD Max Burst frequency performance varies depending on hardware, software and overall system configuration.
- 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.



### **Technical Specifications**

#### **CHIPSET**

Chipset is integrated with processor

#### **GRAPHICS**

#### Integrated

AMD Radeon™ Graphics7

**Note:** View processor section for details.

#### Supports

Support HD decode, DX12, HDMI 1.4

7. HD content required to view HD images.

#### **DISPLAY**

#### Internal

#### Non-Touch

39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED backlit slim, 220 cd/m², 45% NTSC (1366 x 768)<sup>7,8</sup>
39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED backlit slim, 220 cd/m², 45% NTSC for HD camera (1366 x 768)<sup>7,8</sup>
39.6 cm (15.6") diagonal HD SVA eDP anti-glare LED backlit slim, 220 cd/m², 45% NTSC for HD + IR camera (1366 x 768)<sup>7,8</sup>
39.6 cm (15.6") diagonal FHD IPS eDP anti-glare LED-backlit slim, 250 cd/m², 45% NTSC (1920 x 1080)<sup>7,8</sup>
39.6 cm (15.6") diagonal FHD IPS eDP anti-glare LED-backlit slim, 250 cd/m², 45% NTSC for HD camera (1920 x 1080)<sup>7,8</sup>
39.6 cm (15.6") diagonal FHD IPS eDP anti-glare LED-backlit slim, 250 cd/m², 45% NTSC for HD + IR camera (1920 x 1080)<sup>7,8</sup>
39.6 cm (15.6") diagonal FHD eDP+PSR anti-glare LED-backlit flat, 1000 cd/m², 72% NTSC for HD Webcam Privacy (1920x1080)<sup>7,8</sup>

Supports narrow bezel

#### **HDMI**

HDMI1.4b, up to 4K 30Hz

- 7. HD content required to view HD images.
- 8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.



### **Technical Specifications**

#### STORAGE AND DRIVES

#### **Primary Storage**

500 GB 7200 rpm SATA<sup>9</sup> 1 TB 5400 rpm SATA<sup>9</sup>

#### **Primary M.2 Storage**

128 GB SATA TLC Solid State Drive<sup>9</sup>
256 GB PCIe<sup>®</sup> NVMe<sup>™</sup> Value Solid State Drive<sup>9</sup>
512 GB PCIe<sup>®</sup> NVMe<sup>™</sup> TLC Solid State Drive<sup>9</sup>
512 GB PCIe<sup>®</sup> NVMe<sup>™</sup> Value Solid State Drive<sup>9</sup>

9. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

#### **MEMORY**

#### **Maximum Memory**

16 GB DDR4-3200 SDRAM10

#### Memory

16 GB DDR4-3200 SDRAM (1 x 16 GB)
12 GB DDR4-3200 SDRAM (1 x 4 GB and 1 x 8 GB)<sup>10</sup>
8 GB DDR4-3200 SDRAM (1 x 8 GB)
8 GB DDR4-3200 SDRAM (2 x 4 GB)<sup>10</sup>
4 GB DDR4-3200 SDRAM (1 x 4 GB)

#### **Memory Slots**

2 SODIMM

Both slots are customer accessible / upgradeable by IT or self-maintainers only DDR4 PC4 SODIMMS, system runs at 3200 Supports Dual Channel Memory

10. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

#### **NETWORKING/COMMUNICATIONS**

#### WI AN

Realtek RTL8822CE 802.11 a/b/g/n/ac (2x2) Wi-Fi® + Bluetooth® 5 Combo¹¹ Intel® Dual Band Wi-Fi® 6 AX200 802.11ax (2x2) and Bluetooth® 5 Combo, non-vPro™¹¹ Intel® Dual Band Wireless-AC 9260 802.11 a/b/g/n/ac (2x2) Wi-Fi® and Bluetooth® 5 Combo, non-vPro™¹¹

#### **Ethernet**

Realtek RTL8111EP 10/100/1000 NIC12

11. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported



### **Technical Specifications**

12. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

#### **AUDIO/MULTIMEDIA**

#### Audio

Integrated microphone (Mono or Dual Array)
2 Integrated stereo speakers

#### Camera

720p HD camera<sup>7</sup> 720p HD + IR camera<sup>7,13</sup>

7. HD content required to view HD images.

13. IR camera is an optional feature that must be configured at purchase.

#### **KEYBOARDS/POINTING DEICES/BUTTONS & FUNCTION KEYS**

#### Keyboard

HP Premium Keyboard, spill resistant with numeric keypad and optional backlit<sup>14</sup>

#### **Pointing Device**

Clickpad with multi-touch gesture support

#### **Function Keys**

F1 - Display Switching

F2 - Blank or SureView On/Off

F3 - Brightness Down

F4 - Brightness Up

F5 - Audio Mute

F6 - Volume Down

F7 - Volume Up

F8 - Mic Mute

F9 - Blank or Backlit Toggle

F10 - Blank

F11 - Wireless

F12 - Sleep

#### **Hidden Functions**

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

14. Backlit keyboard is an optional feature that must be configured at purchase.

#### **SOFTWARE AND SECURITY**

#### **BIOS**

HP BIOSphere Gen5<sup>15</sup> HP Drive Lock & Automatic Drive Lock<sup>16</sup> BIOS Update via Network



### **Technical Specifications**

Master Boot Record Security Power On Authentication Secure Erase<sup>17</sup> Absolute Persistence Module<sup>18</sup> Pre-boot Authentication

#### Software

HP Connection Optimizer
HP Image Assistant
HP Hotkey Support
HP JumpStarts
HP Support Assistant<sup>19</sup>
HP Noise Cancellation Software
Buy Office (sold separately)

#### **Manageability Features**

HP Driver Packs<sup>20</sup>
HP System Software Manager (SSM)
HP BIOS Config Utility (BCU)
HP Client Catalog
HP Manageability Integration Kit Gen3<sup>21</sup>

#### **Client Security Software**

HP Client Security Manager Gen5<sup>22</sup> Windows Defender<sup>23</sup> HP Fingerprint Sensor<sup>24</sup>

#### **Security Management**

Pre-boot Authentication
TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)<sup>25</sup>
USB enable/disable (via BIOS)
Power-on password (via BIOS)
Setup password (via BIOS)
Support for chassis padlocks and cable lock devices
HP Fingerprint Sensor<sup>24</sup>
HP Sure Sense<sup>26</sup>
HP Sure Click<sup>27</sup>
HP Sure Start Gen5<sup>28</sup>

15. HP BIOSphere Gen5 is available on select HP Pro and Elite PCs. See product specifications for details. Features may vary depending on the platform and configurations.

16. HP Drive Lock & Automatic Drive Lock is not supported on NVMe drives

17. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

18. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/.

19. HP Support Assistant requires Windows and Internet access.

20. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.

21. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.

22. HP Client Security Manager Gen5 requires Windows and is available on the select HP Pro and Elite PCs. See product specifications for details.

23. Windows Defender Opt in and internet connection required for updates.



### **Technical Specifications**

- 24. HP Fingerprint Sensor is an optional feature and requires configuration at purchase.
- 25. Firmware TPM is version 2.0.
- 26. HP Sure Sense requires Windows 10. See product specifications for availability. On HP Elite x2 G4 units with WWAN shipping to China, HP Sure Sense is only available via Softpaq download.
- 27. HP Sure Click is available on select HP platforms and supports Microsoft Internet Explorer, Google Chrome™, and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.
- 28. HP Sure Start Gen5 is available on select HP PCs with Intel processors. See product specifications for availability.

#### **POWER**

#### **Power Supply**

HP Smart 65 W External AC power adapter<sup>29</sup> HP Smart 65 W EM External AC power adapter<sup>29</sup> HP Smart 65 W USB Type-C<sup>®</sup> adapter<sup>29</sup> HP Smart 45 W External AC power adapter<sup>29</sup> HP Smart 45 W USB Type-C<sup>®</sup> adapter<sup>29</sup>

#### **Power Cord**

3-wire plug - 1.8 m<sup>29</sup>
3-wire plug - 1.0 m<sup>29</sup>
2-wire plug - 1.0 m<sup>29</sup>
Duckhead power cord - 1.0 m<sup>29</sup>
Duckhead power cord - 1.8 m<sup>29</sup>

#### **Primary Battery**

HP Long Life 3-cell, 45 Wh Li-ion polymer<sup>30</sup>

#### **Battery Life**

14 hours<sup>31</sup>

#### **Battery Weight**

0.22 kg 0.49 lb

- 29. Availability may vary by country.
- 30. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 31. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See <a href="http://www.bapco.com">http://www.bapco.com</a> for additional details..



### **Technical Specifications**

#### **WEIGHTS & DIMENSIONS**

#### Weight

Starting at 4.41 lb<sup>32</sup> Starting at 2.0 kg<sup>32</sup>

#### Dimensions (w x d x h)

14.37 x 10.11 x 0.75 in 36.49 x 25.69 x 1.89 cm

32. Weight will vary by configuration. Does not include power adapter.

#### **PORTS/SLOTS**

#### **Ports**

1 USB 3.1 Type-C® Gen 1 (Power delivery, DisplayPort™)

2 USB 3.1 Gen 1

1 USB 2.0 (powered port)

1 HDMI 1.4<sup>33</sup>

1 RJ-45

1 AC power

1 stereo headphone/microphone combo jack

#### **Expansion Slots**

1SD

Supports SD, SDHC, SDXC

33. HDMI cable sold separately.



### **Technical Specifications**

#### **SYSTEM UNIT**

## Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage 19V Average Operating Power 8.1 W

Integrated graphics Yes (AMD Radeon™ Graphics)

Max Operating Power Discrete < 65 W

**UMA < 45 W** 

Temperature

Operating 32° to 95° F (0° to 35° C) (Not writing optical) Non-operating -4° to 140° F (-20° to 60° C) (Writing optical)

**Relative Humidity** 

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock

Operating 40 G, 2 ms, half-sine Non-operating 200 G, 2 ms, half-sine

**Random Vibration** 

Operating 0.75 grms Non-operating 1.50 grms

**Altitude (unpressurized)** 

Operating -50 to 10,000 ft (-15.24 to 3,048 m)

Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

Yes

**Planned Industry Standard** 

Certifications

UL Yes
CSA Yes
FCC Compliance Yes

Energy Star® Selected models<sup>35</sup>
EPEAT® 2019 Yes. Gold in U.S.<sup>36</sup>

**ICES** Yes Australia Yes NZ A-Tick Compliance Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes



GOST

### **Technical Specifications**

Saudi Arabian Compliance (ICCP) Yes SABS Yes

35. Configurations of the HP ProBook 455 G7 that are ENERGY STAR® qualified are identified as HP ProBook 455 G7 ENERGY STAR® on HP websites and on http://www.energystar.gov.

36. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit http://www.epeat.net for more information.

#### **DISPLAYS**

**NOTE**: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Panel LCD 15.6 inch diagonal HD (1366 x 768) Anti-Glare WLED SVA 45% NTSC 220 nits eDP 1.2 w/o PSR slim NB non-touch 

 Outline Dimensions (W x H x D)
 350.96 x 216.75 (max.)

 Active Area
 344.16 x 193.59 (typ.)

Weight <370g max.

Diagonal Size 15.6"

Thickness 3.2mm max.
Interface eDP 1.2
Surface Treatment Anti-glare

Touch Enabled No

Contrast Ratio 300:1 (typ)
Refresh Rate 60Hz

**Brightness** 220 nits typical (Panel Only)

Pixel Resolution 1366 x 768 (HD)

Format of LCD Pixel Arrangement RGB Backlight LED

Color Gamut Coverage45% of NTSCColor Depth6 bits + Hi FRCViewing AngleSVA 40/40/15/30

Panel LCD 15.6 inch diagonal FHD (1920 x 1080) Anti-Glare WLED UWVA 45% NTSC 250 nits eDP 1.2 w/o PSR slim NWBZ

 Outline Dimensions (W x H x D)
 350.96 x 216.65 mm (max)

 Active Area
 344.16 x 193.59 mm (typ.)

Weight 370 g (max)

Diagonal Size 15.6 inch

Thickness 3.2 mm (max)

Interface eDP 1.2 (2 lane)

Surface Treatment Anti-Glare

Touch Enabled No

Contrast Ratio 600:1 (typ.)
Refresh Rate 60 Hz



### **Technical Specifications**

**Brightness** 250 nits

Pixel Resolution 1920 x 1080 (FHD)

Format of LCD Pixel Arrangement RGB Backlight LED

**Color Gamut Coverage** 45% of NTSC

**Color Depth** 6 bits

Viewing Angle UWVA 85/85/85

Panel LCD 15.6 inch Outline Dim diagonal FHD (1920 x 1080) Active Area Anti-Glare WLED UWVA 72% Weight NTSC 1000 nits eDP 1.4+PSR2 flat Privacy Diagonal Si:

 Outline Dimensions (W x H x D)
 349.52 x 204.79 mm (max)

 Active Area
 344.16 x 193.59 mm (typ.)

 Weight
 350 g (max)

 Diagonal Size
 15.6 inch

 Thickness
 2.6 mm (max)

Interface eDP 1.4 + PSR2 (4 lane)

Surface Treatment Anti-Glare

**Touch Enabled** No

Contrast Ratio2000:1 (typ.)Refresh Rate60 HzBrightness1000 nits

Pixel Resolution 1920 x 1080 (FHD)

Format of LCD Pixel Arrangement RGB Backlight LED

**Color Gamut Coverage** 72% of NTSC

Color Depth 8 bits

Viewing Angle UWVA 85/85/85



### **Technical Specifications**

#### STORAGE AND DRIVES

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software

500 GB 7200 rpm SATA Hard Drive **Drive Weight** 0.20 lbs (92 g) ~ 0.21 lbs (95 g)

Rotation speed7200 rpmCache BufferUp to 32 MBHeight0.28 in (7 mm)Width2.75 in (69.85 mm)InterfaceATA-8, SATA 3.0

Transfer Rate 600 MB/s
Seek Time Single Track: 2 ~

Seek Time Single Track: 2 ~ 1.5 ms Average: 11 ~ 13 ms

Maximum: 18 ~ 22 ms

**Logical Blocks** 976,773,168

**Operating Temperature** 32° to 140° F (0° to 60° C) [top cover temp]

Security Features ATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

1 TB 5400 rpm SATA Hard Drive

Drive Weight0.21 lbs (94 g)Rotation speed5400 rpmCache BufferUp to 32 MBHeight0.28 in (7.2 mm)Width2.75 in (69.85 mm)InterfaceATA-8, SATA 3.0

Seek Time Single Track: 2 ms

Average: 12 ~ 13 ms Maximum: 18 ~ 22 ms

**Logical Blocks** 1,953,525,168

**Transfer Rate** 

**Operating Temperature** 32° to 140° F (0° to 60° C) [top cover temp]

600 MB/s

Security Features ATA Security

**Features** S.M.A.R.T., NCQ, Ultra DMA



### **Technical Specifications**

SSD 128 GB 2280 M2 SATA-3 TLC

Form Factor M.2 2280
Capacity 128 GB
NAND Type TLC

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 ATA-8, SATA 3.0

 Maximum Sequential Read
 Up To 520 MB/s

 Maximum Sequential Write
 Up To 450 MB/s

 Logical Blocks
 250,069,680

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features DIPM; TRIM; DEVSLP

256 GB 2280 PCIe NVMe Value Solid State Drive Form Factor M.2 2280
Capacity 256 GB
NAND Type TLC

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3Maximum Sequential ReadUp To 1700 MB/sMaximum Sequential WriteUp To 1300 MB/sLogical Blocks500,118,192

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2

512 GB 2280 M2 PCIe NVMe Form Factor TLC Solid State Drive Capacity

Form Factor M.2 2280
Capacity 512 GB
NAND Type TLC

Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3X4Maximum Sequential ReadUp To 2600 MB/sMaximum Sequential WriteUp To 1400 MB/sLogical Blocks1,000,215,216

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2



### **Technical Specifications**

512 GB 2280 PCIe NVMe Value Solid State Drive

Form Factor M.2 2280
Capacity 512 GB
NAND Type Value

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Weight
 0.02 lb (10 g)

 Interface
 PCIe NVMe Gen3X4

 Maximum Sequential Read
 Up To 1500 ~ 1700 MB/s

 Maximum Sequential Write
 Up To 860 ~ 1500 MB/s

**Logical Blocks** 1,000,215,216

**Operating Temperature** 32° to 158°F (0° to 70°C) [ambient temp]

**Features** ATA Security, TRIM; L1.2



### **Technical Specifications**

#### **NETWORKING/COMMUNICATIONS**

Intel® Wi-Fi 61 AX200 and Wireless LAN Standards IEEE 802.11a IEEE 802.11b Bluetooth® 5.0 802.11ax IEEE 802.11q (2x2). non-vPro. IEEE 802.11n supporting gigabit file IEEE 802.11ac transfer speeds IEEE 802.11ax non-vPro IFFF 802.11d IEEE 802.11e IEEE 802.11h

IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

Interoperability Wi-Fi CERTIFIED™ **Frequency Band** •802.11b/g/n/ax

> 2.402 - 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz

**Data Rates** •802.11b: 1, 2, 5.5, 11 Mbps

> •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, 80MHz &

160MHz)

Modulation Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security<sup>3</sup> • IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

• 802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

• IEEE 802.11i

WAPI

**Network Architecture** 

Ad-hoc (Peer to Peer)

Models

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points Output Power<sup>2</sup>

• 802.11b: +18.5dBm minimum 802.11g: +17.5dBm minimum

• 802.11a: +18.5dBm minimum

• 802.11n HT20(2.4GHz): +15.5dBm minimum • 802.11n HT40(2.4GHz): +14.5dBm minimum • 802.11n HT20(5GHz): +15.5dBm minimum



### **Technical Specifications**

802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum
802.11ac VHT160(5GHz): +11.5dBm minimum
802.11ax HT40(2.4GHz): +10dBm minimum
802.11ax VHT160(5GHz): +10dBm minimum

Power Consumption • Transmit mode 2.0 W

• Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode 50 mW (WLAN unassociated)

Connected Standby 10 mW
 Radio disabled 8 mW

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity**<sup>4</sup> • 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum
802.11a/g, 6Mbps: -86dBm maximum
802.11a/g, 54Mbps: -72dBm maximum
802.11n, MCS07: -67dBm maximum
802.11n, MCS15: -64dBm maximum
802.11ac, MCS0: -84dBm maximum
802.11ac, MCS9: -59dBm maximum

802.11ax, MCS11(HT40): -59dBm maximum
802.11ax, MCS11(VHT160): -58.5dBm maximum

**Antenna type** High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** 1. Type 2230 : 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** 1. Type 2230 : 2.8 q

2. Type 126: 1.3 g

**Operating Voltage** 3.3v +/- 9%

**Temperature** Operating Operating: 14° to 158° F (–10° to 70° C)

Non-operating: -40° to 176° F (-40° to 80° C)

**Humidity** Operating Operating: 10% to 90% (non-condensing)

Non-operating Non-operating: 5% to 95% (non-condensing)

**Altitude** Operating Operating: 0 to 10,000 ft (3,048 m)

Non-operating Non-operating: 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF

LED OFF – Radio ON

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

**Bluetooth® Specification** 4.0/4.1/4.2/5.0/5.1 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)

Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate<sup>4</sup> Legacy: 3 Mbps Signaling Data Rate 2.17 Mbps



### **Technical Specifications**

BLE: 1 Mbps Signaling Data Rate 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 9.5 dBm for BR and EDR.

**Power Consumption** Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

**Bluetooth Software** 

Supported Link Topology Microsoft Windows Bluetooth Software

**Power Management** Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices. Only available in countries where 802.11ax is supported.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of

transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



### **Technical Specifications**

Intel® 802.11a/b/g/n/ac Wireless LAN Standards (2x2) Wi-Fi® and IEEE 802.11b
Bluetooth® 5.0 Combo¹ IEEE 802.11g
Non-vPro IEEE 802.11n

IEEE 802.11n
IEEE 802.11ac
IEEE 802.11d
IEEE 802.11e
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k
IEEE 802.11r
IEEE 802.11v

**Interoperability** Wi-Fi CERTIFIED™ Frequency Band •802.11b/g/n

2.402 – 2.482 GHz •802.11a/n/ac

4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

**Data Rates** •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz & 160MHz)

**Modulation** Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security<sup>3</sup> •IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification •IEEE 802.11i •WAPI

**Network Architecture** 

Models

Output Power<sup>2</sup>

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

**Roaming** IEEE 802.11 compliant roaming between access points

802.11b: +18.5dBm minimum
802.11g: +17.5dBm minimum
802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum
802.11ac VHT160(5GHz): +11.5dBm minimum

Power Consumption • Transmit mode 2.0 W

•Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

•Radio disabled 8 mW



### **Technical Specifications**

**Power Management** ACPI and PCI Express compliant power management

802.11 compliant power saving mode

**Receiver Sensitivity<sup>4</sup>** 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

**Antenna type** High efficiency antenna.

One embedded dual band 2.4/5 GHz antenna is provided to the card to

support WLAN communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

**Dimensions** Type 2230: 2.3 x 22.0 x 30.0 mm

Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** Type 2230: 2.8 g

Type 126: 1.3 g

**Operating Voltage** 3.3v +/- 9%

**Temperature** Operating: 14° to 158° F (–10° to 70° C)

Non-operating: -40° to 176° F (-40° to 80° C)

**Humidity** Operating: 10% to 90% (non-condensing)

Non-operating: 5% to 95% (non-condensing)

**Altitude** Operating: 0 to 10,000 ft (3,048 m)

Non-operating: 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber – Radio OFF

LED OFF - Radio ON

#### HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

**Bluetooth Specification** 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz
Number of Available Legacy: 0~79 (1 MHz/CH)

Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps Signaling Data Rate 2.17 Mbps

BLE: 1 Mbps Signaling Data Rate 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Electrical Interface USB 2.0 compliant

Bluetooth Software Microsoft Wine

Supported

Supported Link Topology Microsoft Windows Bluetooth Software



### **Technical Specifications**

**Power Management** Microsoft Windows ACPI, and USB Bus Support Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

**Power Management** ETS 300 328, ETS 300 826 Certifications Low Voltage Directive IEC950

UL, CSA, and CE Mark

**Bluetooth Profiles** BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping Supported

LE Dual Mode LE Link Laver

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Wi-Fi® and Bluetooth®

5.0

802.11a/b/g/n/ac (2x2) Wireless LAN Standards IEEE 802.11a IEEE 802.11b IEEE 802.11q IEEE 802.11n

IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v

Wi-Fi CERTIFIED™ Interoperability **Frequency Band** •802.11b/q/n 2.402 - 2.482 GHz

•802.11a/n/ac 4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz

5.25 - 5.35 GHz 5.47 - 5.725 GHz



### **Technical Specifications**

5.825 - 5.850 GHz

**Data Rates** •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz & 80MHz)

**Modulation** Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security<sup>3</sup> •IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

•WPA2 certification •IEEE 802.11i •WAPI

**Network Architecture** 

Models Roaming Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Output Power<sup>2</sup>

IEEE 802.11 compliant roaming between access points
• 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum
802.11ac VHT160(5GHz): +11.5dBm minimum

**Power Consumption** 

•Transmit mode: 2.0 W •Receive mode: 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

Radio disabled: 8 mW

**Power Management** 

ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity<sup>4</sup>

802.11b, 1Mbps: -93.5dBm maximum 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type

High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

**Dimensions** Type 2230: 2.3 x 22.0 x 30.0 mm

Type 1216: 1.67 x 12.0 x 16.0 mm

**Weight** Type 2230: 2.8 g

Type 126: 1.3 g



### **Technical Specifications**

**Operating Voltage** 3.3v +/- 9%

**Temperature** Operating: 14° to 158° F (-10° to 70° C)

Non-operating: -40° to 176° F (-40° to 80° C)

**Humidity** Operating: 10% to 90% (non-condensing)

Non-operating: 5% to 95% (non-condensing)

Operating: 0 to 10.000 ft (3.048 m) **Altitude** 

Non-operating: 0 to 50,000 ft (15,240 m)

**LED Activity** LED Amber - Radio OFF

LED OFF - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0 Wireless Technology

Legacy: 0~79 (1 MHz/CH)

**Bluetooth Specification** 4.0/4.1/4.2/5.0 Compliant

**Frequency Band** 2402 to 2480 MHz

**Number of Available** 

Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps Signaling Data Rate 2.17 Mbps

BLE: 1 Mbps Signaling Data Rate 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

**Transmit Power** The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

**Power Consumption** Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Microsoft Windows Bluetooth Software

**Bluetooth Software** 

Supported **Link Topology** 

**Power Management** Microsoft Windows ACPI, and USB Bus Support Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

**Power Management** 

Certifications

ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

**Bluetooth Profiles** 

BT4.1-ESR 5/6/7 Compliance Supported LE Link Layer Ping

**LE Dual Mode** LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance LE Secure Connection- Basic/Full

LE Privacy 1.2 -Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP)



### **Technical Specifications**

Hands Free Profile (HFP)
Advanced Audio Distribution Profile (A2DP)

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited.
- 2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Realtek RTK8111HSH
10/100/1000 Integrated
NIC

Connector RJ-45
System Interface PCIe + SMBus

Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-

30)

1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

**Power Management** ACPI compliant – multiple power modes

Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power

consumption

**Performance Features** TCP/IP/UDP Checksum Offload (configurable)

Protocol Offload (ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling Jumbo Frame 9K

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft

Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30)

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Management Interface Auto MDI/MDIX Crossover cable detection



### **Technical Specifications**

#### **POWER**

HP 45 W Smart AC adapter **Dimensions (H x W x D)** 3.74 x 1.57 x 1.04 in (9.5 x 4.0 x 2.65 cm)

**Weight** 0.386 lb (175 g) max

Not including power cord. Power cord varies by country

**Input** 90 to 265 VAC

**Input Efficiency** 87.74% at 115 VAC and 88.4% at 230

VAC

Input frequency range 47 to 63 Hz
Input AC current 1.4 A at 90 VAC

Output Output power 45 W

**DC output** 19.5 V

**Hold-up time** 5 msec at 115 VAC input

Output current limit <8.0 A

**Connector** 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating

temperature

32° to 95° F (0° to 35° C)

Non-operating (storage) -4° to 185° F (-20° to 85° C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% Storage Humidity 10% to 95%

EMI and Safety Certifications \*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65 W Smart AC adapter 

 Dimensions
 90 x 51 x 28.5 mm

 Weight
 220 g +/- 10 g

Not including power cord. Power cord varies by country

Input Input Efficiency 88% min at 115 VAC and 89.0% at 230 VAC

**Input frequency range** 47 to 63 Hz

**Input AC current** Max. 1.7 A at 90 VAC

Output Output power 65 W

**DC output** 19.5 V

**Hold-up time** 5 msec at 115 VAC input

Output current limit <11.0 A

**Connector** 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature



### **Technical Specifications**

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications \*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65 W EM Smart AC adapter **Dimensions** 102 x 55 x 30 mm

**Weight** 270g +/- 10g

Not including power cord. Power cord varies by country

**Input Efficiency** 87% min at 115V/230V

**Input frequency range** 47 to 63 Hz

Input AC current 1.7 A at 90 Vac and maximum load

DC output 65 W (19.5V/3.33A)

Hold-up time 5 msec at 115 VAC input

**Output current limit** <11 A, Over voltage protection- 29V max

automatic shutdown

**Connector** 4.5mm Barrel Type, 3 pin/grounded, mates with interchangeable cords

**Environmental Design** Operating 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

Altitude 0 to 5,000 m Humidity 0% to 95% Storage Humidity 0% to 95%

EMI and Safety Certifications \*CE Mark - EMC directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; Reliability - failure rate of less than 0.1% annually within the first three years of operation.

\*MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt nPFC Dimensions USB Type-C®

 Dimensions
 74 x 74 x 28.5 mm

 Weight
 245 q +/- 10 q

Not including power cord. Power cord varies by country

Input Input Efficiency 81.5% min at 115 Vac/ 230Vac @ 5V/3A

86.7% min at 115 Vac/ 230Vac @ 9V/3A 88% min at 115 Vac/ 230Vac @ 10V/5A 88% min at 115 Vac/ 230Vac @ 12V/5A 89% min at 115 Vac/ 230Vac @ 15V/4.33A

89% min at 115 Vac/ 230Vac @ 20V/3.25A



### **Technical Specifications**

Input frequency range 47 to 63 Hz

**Input AC current** 1.7 A at 90 VAC and maximum load

Output power 65 W

**DC output** 5V/9V/10V/12V/15V/20V **Hold-up time** 5ms at 115 VAC input

Output current limit <8.0A

Connector USB Type-C®

**Environmental Design** Operating 32° F to 95° F (0° to 35° C)

temperature

**Non-operating (storage)** -4° F to 185° F (-20° to 85° C)

temperature

**Altitude** 0 to 16,400 ft (0 to 5000m)

Humidity5% to 95%Storage Humidity5% to 95%

EMI and Safety Certifications \*CE Mark - full compliance with LVD and EMC directives

\* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B,

FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 45 Watt nPFC Dimensions USB Type-C®

**Dimensions** 94.0mm x 40.0mm x 26.5mm

**Weight** 192.5q +/-10%

Not including power cord. Power cord varies by country

Input Input Efficiency Average Efficiency of 25%, 50%, 75%, 100%

load condition with 115Vac/230Vac Spec:

5V:81.5% 9V:86.7% 12V:87.41% 15V:87.8%

**Input frequency range** 47 to 63 Hz

Input AC current Max. 1.4 A at 90 VAC

Output power 5V/15W

9V/27W 12V/36W 15V/45W

**DC output** 5V/9V/12V/15V **Hold-up time** 5ms at 115 VAC input

Output current limit <5.0 A

**Connector** USB Type-C®

Environmental Design Operating 32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature



### **Technical Specifications**

**Altitude** 0 to 16,400 ft (0 to 5000m)

**Humidity** 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications \*CE Mark - full compliance with LVD and EMC directives

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FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

\* MTBF - over 200,000 hours at 25°C ambient condition.

3 Cell WHr 45 Long Life -Polymer HP Fast Charge Technology<sup>1</sup> **Dimensions (H x W x L)** 6.0 x 184.7 x 88.9 mm

Weight 0.22 kg (0.48 lb)
Cells/Type 3cell Lithium-Ion

Voltage 11.55 V
Amp-hour capacity 3.900 Ah
Watt-hour capacity 45 Wh

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F (-10° to 60° C)

Optional Travel Battery

Available

No



<sup>1.</sup> Recharges the battery up to 50% within 30 minutes when the system is off or in standby mode when used with the power adapter provided with the notebook. After charging has reached 50% capacity, charging speed will return to normal. Charging time may vary +/-10% due to System tolerance.

## Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part Number
Cases	HP Essential Top Load Case	H2W17AA
	HP Essential Backpack (up to 15.6")	H1D24AA
	HP 17.3 Business Backpack	2SC67AA
Docking	HP USB-C Mini Dock	1PM64AA
DUCKING	HP Thunderbolt Dock 120W G2	2UK37AA
	HP TB Dock G2 w/ Combo Cable	3TR87AA
	HP TB Dock 120W G2 w/Audio	3YE87AA
	HP TB Dock 120W G2 W/Addio  HP TB Dock 120W G2 Cable	3XB94AA
	HP TB Dock G2 Combo Cable	3XB96AA
	HP TB Dock G2 Audio Module	
	HP USB-C/A Universal Dock G2	3AQ21AA 5TW13AA
	HP USB-C Dock G5	5TW10AA 5TW10AA
	NF USB-C DUCK US	SIWIUAA
Input / Output	HP USB Essential Keyboard and Mouse	H6L29AA
	HP Bluetooth Travel Mouse	6SP30AA
	HP Ultra Mobile Wireless Mouse	H6F25AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP USB Travel Mouse	G1K28AA
	HP HDMI to DVI Adapter	F5A28AA
	HP Elite USB-C Hub	4WX89AA
	HP USB-C Travel Hub G2	7PJ38AA
Power	HP 45W Smart AC Adapter 4.5mm	H6Y88AA
	65W Smart Power Adapter (w/ 4.5mm to 7.5mm DC dongle)	H6Y89AA
	HP 65W Slim AC Adapter	H6Y82AA
	HP 65W USB-C Slim Power Adapter	3PN48AA
	HP 65W USB-C Power Adapter	1HE08AA
	HP 45W USB-C Power Adapter	1HE07AA
	HP Power Bank	N9F71AA
	HP USB-C Power Bank	2NA10AA
Storage	HP External USB Optical Drive	F2B56AA
Security	HP Keyed Cable Lock 10mm	T1A62AA
<b>-</b>	HP Sure Key Cable Lock	6UW42AA
	•,	



## Options and Accessories (sold separately and availability may vary by country)

**Displays** HP E223d Docking Monitor (Santino)

HP E243d Docking Monitor (Sonny)

HP E273d Docking Monitor (Vito)

HP EliteDisplay E244d Monitor (Sand Dollar) HP EliteDisplay E274d Monitor (Glomar) 5VT82A8/5VT82AA

1TJ76AA

5WN63A8/5WN63AA

6PA50A8/6PA50AA

6PA56A8/6PA56AA



### **Summary of Changes**

Date of change:	Version History:		Description of change:
April 29, 2020	V1 to V2	Updated	MIL-STD 810G to MIL-STD 810H
May 7, 2020	V2 to V3	Updated	Ethernet Section

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